

□ MN101C67D, MN101C67G

Type	MN101C67D (under planning)	MN101C67G (under development)
ROM (×8-bit)	64 K	128 K
RAM (×8-bit)	6 K	10 K
Package	TQFP080-P-1212D *Lead-free	
Minimum Instruction Execution Time	Standard: 0.1 μs (at 2.5 V to 3.6 V, 20 MHz)* 0.2 μs (at 2.1 V to 3.6 V, 10 MHz)* 0.5 μs (at 1.8 V to 3.6 V, 4 MHz)* 62.5 μs (at 1.8 V to 3.6 V, 32 kHz)* Double speed: 0.119 μs (at 2.5 V to 3.6 V, 8.39 MHz)* * The operation guarantee range for flash memory built-in type is 3.0 V to 3.6 V.	
Interrupts	<ul style="list-style-type: none"> • RESET • Watchdog • External 0 • External 1 • External 2 • External 3 • External 4 • External 5 • Timer 0 • Timer 1 • Timer 2 • Timer 3 • Timer 4 • Timer 5 • Timer 6 • Time base • Serial 0 reception • Serial 0 transmission • Serial 1 reception • Serial 1 transmission • Serial 2 • Serial 3 • Serial 4 • Automatic transfer finish • A/D conversion finish • Timer 7 (2 systems) • Key interrupts (8 lines) 	
Timer Counter	<p>Timer counter 0 : 8-bit × 1 (square-wave/8-bit PWM output, event count, generation of remote control carrier, pulse width measurement) Clock source 1/2, 1/4 of system clock frequency; 1/1, 1/4, 1/16, 1/32, 1/64 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency; external clock input Interrupt source coincidence with compare register 0</p> <p>Timer counter 1 : 8-bit × 1 (square-wave output, event count, synchronous output event) Clock source 1/2, 1/8 of system clock frequency; 1/1, 1/4, 1/16, 1/64, 1/128 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency; external clock input Interrupt source coincidence with compare register 1</p> <p>Timer counter 0, 1 can be cascade-connected.</p> <p>Timer counter 2 : 8-bit × 1 (square-wave/8-bit PWM output, event count, synchronous output event, pulse width measurement) Clock source 1/2, 1/4 of system clock frequency; 1/1, 1/4, 1/16, 1/32, 1/64 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency; external clock input Interrupt source coincidence with compare register 2</p> <p>Timer counter 3 : 8-bit × 1 (square-wave output, event count, generation of remote control carrier) Clock source 1/2, 1/8 of system clock frequency; 1/1, 1/4, 1/16, 1/64, 1/128 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency; external clock input Interrupt source coincidence with compare register 3</p> <p>Timer counter 2, 3 can be cascade-connected.</p> <p>Timer counter 4 : 8-bit × 1 (square-wave/8-bit PWM output, event count, pulse width measurement, serial 1 baud rate timer) Clock source 1/2, 1/4 of system clock frequency; 1/1, 1/4, 1/16, 1/32, 1/64 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency; 1/1 of external clock input frequency Interrupt source coincidence with compare register 4</p> <p>Timer counter 5 : 8-bit × 1 (square-wave/8-bit PWM output, event count, pulse width measurement, serial 0 baud rate timer) Clock source 1/2, 1/4 of system clock frequency; 1/1, 1/4, 1/16, 1/32, 1/64 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency; 1/1 of external clock input frequency Interrupt source coincidence with compare register 5</p>	

Timer Counter (Continue)	Timer counter 6 : 8-bit freerun timer
	Clock source 1/1 of system clock frequency; 1/1, 1/4096, 1/8192 of OSC oscillation clock frequency; 1/1, 1/4096, 1/8192 of XI oscillation clock frequency
	Interrupt source coincidence with compare register 6
	Timer counter 7 : 16-bit × 1
	(square-wave/16-bit PWM output, cycle / duty continuous variable, event count, synchronous output event, pulse width measurement, input capture)
	Clock source 1/1, 1/2, 1/4, 1/16 of system clock frequency; 1/1, 1/2, 1/4, 1/16 of OSC oscillation clock frequency; 1/1, 1/2, 1/4, 1/16 of external clock input frequency
	Interrupt source coincidence with compare register 7 (2 lines)
	Time base timer (one-minute count setting)
	Clock source 1/1 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency
	Interrupt source 1/128, 1/256, 1/512, 1/1024, 1/8192, 1/32768 of clock source frequency
Watchdog timer	
Interrupt source 1/65536, 1/262144, 1/1048576 of system clock frequency	
DMA controller (automatic data transfer)	
Max. Transfer cycles 255	
Starting factor external request, various types of interrupt, software	
Transfer mode 1-byte transfer, word transfer, burst transfer	

Serial Interface	Serial 0 : synchronous type / UART (full-duplex) × 1
	Clock source 1/2, 1/4 of system clock frequency; pulse output of timer counter 5; 1/2, 1/4, 1/16, 1/64 of OSC oscillation clock frequency
	Serial 1 : synchronous type / UART (full-duplex) × 1
	Clock source 1/2, 1/4 of system clock frequency; pulse output of timer counter 4; 1/2, 1/4, 1/16, 1/64 of OSC oscillation clock frequency
	Serial 2 : synchronous type × 1
	Clock source 1/2, 1/4 of system clock frequency; pulse output of timer counter 3; 1/2, 1/4, 1/16, 1/32 of OSC oscillation clock frequency
	Serial 3 : synchronous type/simple I ² C × 1
	Clock source 1/2, 1/4 of system clock frequency; pulse output of timer counter 3; 1/2, 1/4, 1/16, 1/32 of OSC oscillation clock frequency
	Serial 4 : I ² C slave × 1
	Applicable for I ² C high-speed transfer mode, 7 bit/10bit address setting, general call

I/O Pins	I/O	62	• Common use • Specified pull-up resistor available • Input/output selectable (bit unit)
	Input	7	• Common use • Specified pull-up resistor available

A/D Inputs	10-bit × 7-ch. (with S/H)
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Special Ports	Buzzer output, remote control carrier signal output, high-current drive port
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See the next page for electrical characteristics, pin assignment and support tool.

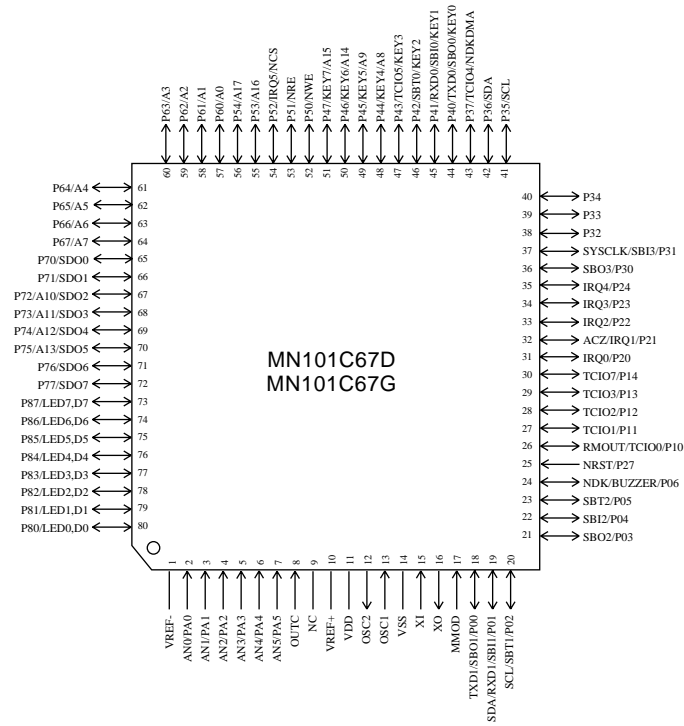
Electrical Characteristics

Supply current

Parameter	Symbol	Condition	Limit			Unit
			min	typ	max	
Operating supply current	IDD1	fosc = 20 MHz, VDD = 3 V, (fs = fosc/2)		5	12	mA
	IDD2	fosc = 8.39 MHz, VDD = 3 V, (fs = fosc/2)		2	5	mA
	IDD3	fx = 32.768 kHz, VDD = 3 V, (fs = fx/2)			40	μA
Supply current at HALT	IDD4	fx = 32.768 kHz, VDD = 3 V, Ta = 25°C		4	8	μA
	IDD5	fx = 32.768 kHz, VDD = 3 V			30	μA
Supply current at STOP	IDD6	VDD = 3 V, Ta = 25°C			2	μA
	IDD7	VDD = 3 V			20	μA

Ta = -40°C to +85°C, VDD = 1.8 V to 3.6 V, VSS = 0 V

Pin Assignment



TQFP080-P-1212D *Lead-free

NC serves as the VPP pin in the MN101CF67G, and cannot be used as a user pin.

Support Tool

■ In-circuit Emulator	PX-ICE101C / D + PX-PRB101C67-TQFP080-P-1212-M	
■ Flash Memory Built-in Type	Type	MN101CF67G [ES (Engineering Sample) available]
	ROM (× 8-bit)	128 K
	RAM (× 8-bit)	10 K
	Minimum instruction execution time	0.1 μs (at 3.0 V to 3.6 V, 20 MHz)
	Package	TQFP080-P-1212D *Lead-free

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